



Hallstrip SN

Hallstrip SN is a single-step, liquid stripping agent that removes solder coatings, tin and tin-copper alloys. Formulated to strip printed wiring boards with minimal attack on the copper substrate. Copper is revealed to be bright, even and shiny. Hallstrip SN is used at room temperature to save on heating costs

Features & Benefits

- Fast stripping time
- No sludge build-up in the tank
- Leaves copper substrate bright and even
- Single step, ready-to-use solution

Equipment

Polypropylene or polyethylene tanks are to be used. Good ventilation is needed to keep exposure under limits.

Operating Conditions

Concentration	Used as is
Temperature	20-28 °C

Maintenance

Solution needs to be replaced once the stripping time is too long for normal operation. The solution rises in temperature depending on the throughput of the operation. Maintain the temperature within recommended range.

WARRANTY: THE QUALITY OF THIS PRODUCT IS GUARANTEED ON SHIPMENT FROM OUR PLANT. IF THE USE RECOMMENDATIONS ARE FOLLOWED, DESIRED RESULTS WILL BE OBTAINED. SINCE THE USE OF OUR PRODUCTS IS BEYOND OUR CONTROL, NO GUARANTEE EXPRESSED OR IMPLIED IS MADE AS TO THE EFFECTS OF SUCH USE, OR THE RESULTS TO BE OBTAINED.



Our People. Your Problem Solvers.

For more information on this process,
please call us at 203.756.5521 or email: techservice@hubbardhall.com

Hubbard-Hall holds certifications for **ISO 9001:2015**, Responsible Distribution, as accredited by the **ACD** (Alliance for Chemical Distributors) and as a **Women-Owned Small Business**, as well as maintaining an association with **Omni-Chem**¹³⁶.